# CRMLTU3016K

#### N-Channel 30V, 390mΩ Typ. Power MOSFET

## **Description**

#### **Features**

• 30V, 0.6A

$$R_{DS(ON)}$$
 Typ = 390m $\Omega$  @  $V_{GS}$  = 10 $V$ 

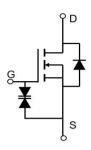
 $R_{DS(ON)}$  Typ = 500m $\Omega$  @  $V_{GS}$  = 4.5V

 $R_{DS(ON)}$  Typ = 1000m $\Omega$  @  $V_{GS}$  = 2.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free
- ESD Protected: 2KV

## **Application**

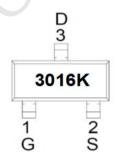
- Load Switch
- PWM Application
- Power Management





Schematic Diagram





**Marking and Pin Assignment** 

## **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTU3016K	3016K	SOT-23	TAPING	7"	3000	120000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		30	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
,	Continuous Drain Current	T <sub>A</sub> = 25°C	0.6	Α
I <sub>D</sub>	Continuous Diain Current	T <sub>A</sub> = 100°C	0.36	Α
I <sub>DM</sub>	Pulsed Drain Current (1)		2.4	Α
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25°C	0.35	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>	2)	357	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

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## **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±10	μΑ
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.5	0.85	1.2	V
		$V_{GS} = 10V, I_D = 0.2A$	-	390	468	mΩ
$R_{\text{DS}(\text{ON})}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 4.5V, I_D = 0.15A$	-	500	600	mΩ
		$V_{GS} = 2.5V, I_D = 0.1A$	- /	1000	1200	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		X - \	20	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	<u> </u>	5	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 1101112	<u> </u>	3	-	pF
Q <sub>g</sub>	Total Gate Charge	16	-	1.5	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_D = 0.3A$	-	0.2	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> - 13V, I <sub>D</sub> - 0.3A	-	0.5	-	nC
Switchin	g Characteristics	.( )				
t <sub>d(on)</sub>	Turn-On DelayTime	-	-	2	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	14	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_{D} = 0.3A, R_{GEN} = 3\Omega$	-	6	-	ns
$t_{f}$	Turn-Off Fall Time		-	19	-	ns
Drain-So	urce Diode Characteristics and N	lax Ratings				
Is	Maximum Continuous Drain to Source Did	ode Forward Current	-	-	0.6	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode F	Forward Current	-	-	2.4	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 0.2A	-	-	1.2	V

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $R_{\text{BJA}}$  is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

<sup>3.</sup> Pulse Test: Pulse Width  $\!\!\leqslant\! 300\mu s,$  Duty Cycle  $\!\!\leqslant\! 0.5\%.$ 

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## **Test Circuit**

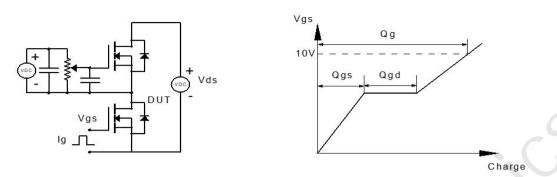


Figure 1: Gate Charge Test Circuit & Waveform

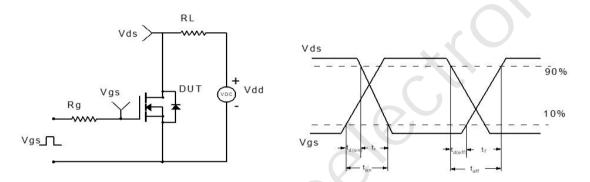


Figure 2: Resistive Switching Test Circuit & Waveform

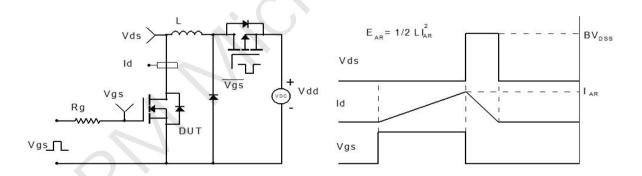


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

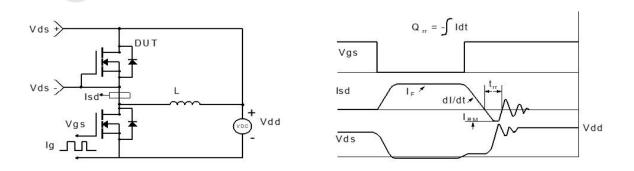
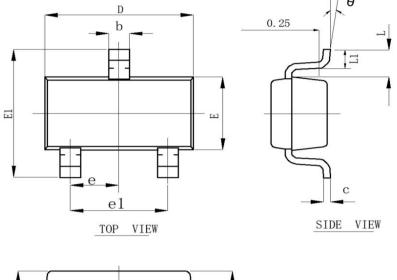


Figure 4: Diode Recovery Test Circuit & Waveform

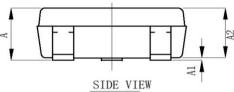
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## Package Mechanical Data(SOT-23)



SYMBOL	MIN	MAX	
A	0. 900	1. 150	
A1	0.000	0. 100	
A2	0.900	1. 050	
b	0. 300	0. 500	
С	0.080	0. 150	
D	2. 800	3. 000	
Е	1. 200	1.400	
E1	2. 250	2.550	
L	0. 550 REF.		
θ	0°	8°	
L1	0. 300	0. 500	
e	0.950 TYP.		
e <sub>1</sub>	1.800	2.000	



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## **Contact information**

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